

PowerMOS transistor

GENERAL DESCRIPTION

N-channel enhancement mode field-effect power transistor in a plastic envelope.

The device is intended for use in Switched Mode Power Supplies (SMPS), motor control, welding, DC/DC and AC/DC converters, and in general purpose switching applications.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
	BUK455			
V_{DS}	Drain-source voltage	-50	-50B	V
I_D	Drain current (DC)	50	50	A
P_{tot}	Total power dissipation	41	38	W
T_j	Junction temperature	125	125	°C
$R_{DS(ON)}$	Drain-source on-state resistance	175	175	Ω
		0.038	0.045	

MECHANICAL DATA

Dimensions in mm

Net Mass: 2g

Pinning:

- 1 = Gate
- 2 = Drain
- 3 = Source

blue binder, tab 4

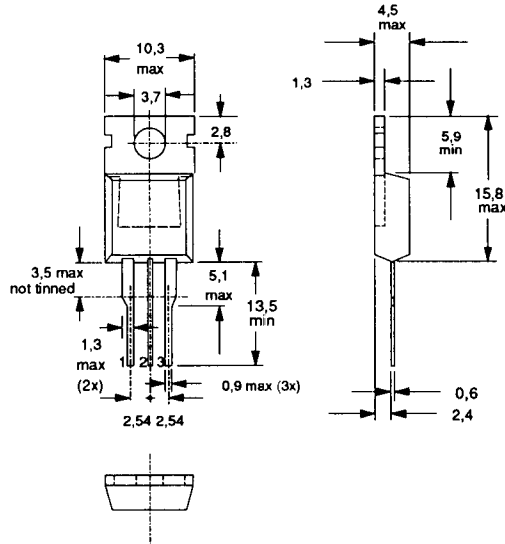
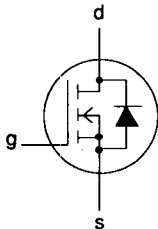


Fig.1 TO220AB; drain connected to mounting base.

Notes

1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
2. Accessories supplied on request: refer to Mounting instructions for TO220 envelopes.

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RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
V_{DS}	Drain-source voltage	-	-	50		V
V_{DGR}	Drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	50		V
$\pm V_{GS}$	Gate-source voltage	-	-	30		V
I_D	Drain current (DC)	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	-50A	-50B	A
I_{D1}	Drain current (DC)	$T_{mb} = 100 \text{ }^\circ\text{C}$	-	41	38	A
I_{DM}	Drain current (pulse peak value)	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	29	27	A
				164	152	A
P_{tot}	Total power dissipation	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	125		W
T_{stg}	Storage temperature	-	-55	175		$^\circ\text{C}$
T_j	Junction Temperature	-	-	175		$^\circ\text{C}$

THERMAL RESISTANCES

From junction to mounting base	$R_{th(j-mb)} = 1.2 \text{ K/W}$
From junction to ambient	$R_{th(j-a)} = 60 \text{ K/W}$

STATIC CHARACTERISTICS

$T_{mb} = 25 \text{ }^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA}$	50	-	-	V
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 1 \text{ mA}$	2.1	3.0	4.0	V
I_{DSS}	Zero gate voltage drain current	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	1	10	μA
I_{DSS}	Zero gate voltage drain current	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ }^\circ\text{C}$	-	0.1	1.0	mA
I_{GSS}	Gate source leakage current	$V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 20 \text{ A}$	-	0.03	0.038	Ω
		BUK455-50A		0.04	0.045	Ω
		BUK455-50B				

DYNAMIC CHARACTERISTICS

$T_{mb} = 25 \text{ }^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g_{fs}	Forward transconductance	$V_{DS} = 25 \text{ V}; I_D = 20 \text{ A}$	8	13.5	-	S
C_{iss}	Input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$	-	1650	2000	pF
C_{oss}	Output capacitance		-	560	750	pF
C_{rss}	Feedback capacitance		-	300	400	pF
t_{don}	Turn-on delay time	$V_{DD} = 30 \text{ V}; I_D = 3 \text{ A};$	-	25	40	ns
t_r	Turn-on rise time	$V_{GS} = 10 \text{ V}; R_{GS} = 50 \text{ } \Omega;$	-	60	90	ns
t_{doff}	Turn-off delay time	$R_{gen} = 50 \text{ } \Omega$	-	125	160	ns
t_f	Turn-off fall time		-	100	130	ns
L_d	Internal drain inductance	Measured from contact screw on tab to centre of die	-	3.5	-	nH
L_{d1}	Internal drain inductance	Measured from drain lead 6 mm from package to centre of die	-	4.5	-	nH
L_s	Internal source inductance	Measured from source lead 6 mm from package to source bond pad	-	7.5	-	nH

REVERSE DIODE RATINGS AND CHARACTERISTICS

$T_{mb} = 25\text{ }^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{DR}	Continuous reverse drain current	-	-	-	41	A
I_{DRM}	Pulsed reverse drain current	-	-	-	164	A
V_{SD}	Diode forward voltage	$I_F = 41\text{ A}; V_{GS} = 0\text{ V}$	-	1.4	2.0	V
t_r	Reverse recovery time	$I_F = 41\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s}; V_{GS} = 0\text{ V}; V_R = 30\text{ V}$	-	250	-	ns
Q_r	Reverse recovery charge	$V_{GS} = 0\text{ V}; V_R = 30\text{ V}$	-	0.30	-	μC

AVALANCHE RATING

$T_{mb} = 25\text{ }^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
W_{DSS}	Drain-source non-repetitive unclamped inductive turn-off energy	$I_D = 41\text{ A}; V_{DD} \leq 25\text{ V}; V_{GS} = 10\text{ V}; R_{GS} = 50\ \Omega$	-	-	100	mJ

